SM30TY

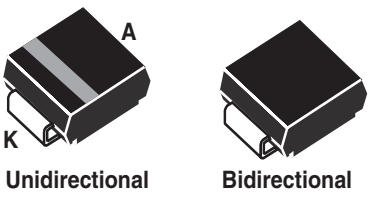
Automotive 3000 W Transil™

Features

- Peak pulse power:
  - 3000 W (10/1000 µs)
  - Up to 28 kW (8/20 µs)
- Stand off voltage range: from 15 V to 33 V
- Unidirectional and bidirectional types
- Operating $T_{j\ max}$: 150 °C
- High power capability at T_{jmax}:
  - 2200 W (10/1000 µs)
- JEDEC registered package outline
- Resin meets UL 94, V0
- AEC qualified

Complies with the following standards

- ISO10605 - C = 150 pF, R = 330 Ω:
  - 25 kV (air discharge)
  - 15 kV (contact discharge)
- ISO10605 - C = 330 pF, R = 330 Ω
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- ISO7637-2[(a)]:
  - Pulse 1 : VS = -100 V
  - Pulse 2a : VS = +50 V
  - Pulse 3a : Vs = -150 V
  - Pulse 3b : Vs = +100 V



Unidirectional Bidirectional

SMC
(JEDEC DO-214AB)

Description

The SM30TY Transil series has been designed to protect automotive sensitive circuits against surges defined in ISO7637-2 and against electro-static discharges according to ISO10605.

The Planar technology makes it compatible with high-end circuits where low leakage current and high junction temperature are required to provide reliability and stability over time. SM30TY are packaged in SMC (SMC footprint in accordance with IPC 7531 standard).

a. Only applicable for parts with stand-off voltage lower than the average battery voltage (13.5 V)

TM: Transil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Symbol	Parameter		Value	Unit
V_{PP}	Peak pulse voltage	ISO10605 (C = 330 pF, R = 330 Ω) contact discharge air discharge IEC 61000-4-2 /ISO10605 (C = 150 pF, R = 330 Ω) contact discharge air discharge	 30 30 30 30	kV
P_{PP}	Peak pulse power dissipation(1)	$T_{j\ initial}$ = T_{amb}	3000	W
T_{stg}	Storage temperature range		-65 to + 150	°C
T_j	Operating junction temperature range		-55 to + 150	°C
T_L	Maximum lead temperature for soldering during 10 s.		260	°C

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal parameter

Symbol	Parameter	Value	Unit
$R_{th(j-l)}$	Junction to leads	15	°C/W
$R_{th(j-a)}$	Junction to ambient on printed circuit on recommended pad layout	90	°C/W

Figure 1. Electrical characteristics - definitions

Symbol	Parameter
V_{RM}	Stand-off voltage
V_{BR}	Breakdown voltage
V_{CL}	Clamping voltage
I_{RM}	Leakage current @ V_{RM}
I_{PP}	Peak pulse current
αT	Voltage temperature coefficient
V_F	Forward voltage drop
R_D	Dynamic resistance

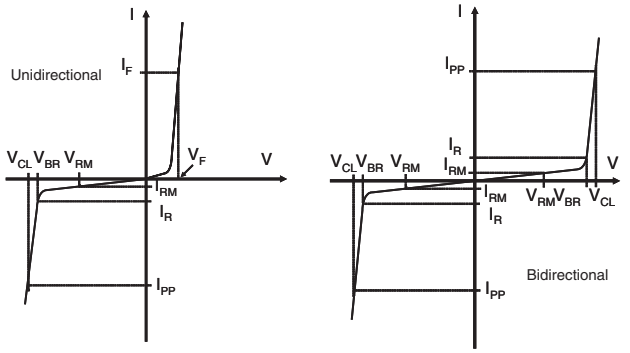


Figure 2. Pulse definition for electrical characteristics

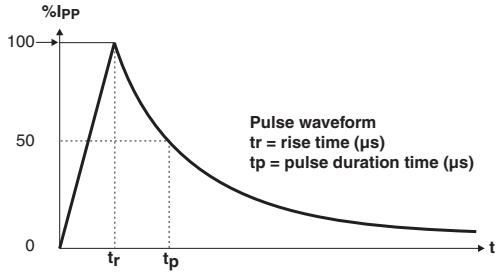


Table 3. Electrical characteristics, parameter values (T_{amb} = 25 °C)

Order code	I_{RM} max@V_{RM}		V_{BR} @I_R (1)				V_{CL} @I_{PP} 10/1000 µs		R_D 10/1000 µs	V_{CL} @I_{PP} 8/20 µs		R_D 8/20 µs	αT (2)
			min	typ	max		max			max			max
	µA	V	V			mA	V(3)	A(4)	Ω	V(3)	A(4)	Ω	10-4/°C
SM30T18AY/CAY	0.2	15	16.7	17.6	18.5	1	24.4	123.0	0.055	30.0	910	0.014	8.8
SM30T19AY/CAY	0.2	16	17.8	18.7	19.6	1	26.0	115.4	0.063	31.5	870	0.015	8.8
SM30T21AY/CAY	0.2	18	20	21.1	22.2	1	29.2	102.7	0.079	35.0	790	0.018	9.2
SM30T23AY/CAY	0.2	20	22.2	23.4	24.6	1	32.4	92.6	0.097	37.5	730	0.019	9.4
SM30T26AY/CAY	0.2	22	24.4	25.7	27.0	1	35.5	84.5	0.116	40.5	680	0.022	9.6
SM30T28AY/CAY	0.2	24	26.7	28.1	29.5	1	38.9	77.1	0.140	43.9	630	0.025	9.6
SM30T30AY/CAY	0.2	26	28.9	30.4	31.9	1	42.1	71.3	0.164	47.0	600	0.028	9.7
SM30T33AY/CAY	0.2	28	31.1	32.7	34.3	1	45.4	66.1	0.192	50.0	560	0.031	9.8
SM30T35AY/CAY	0.2	30	33.3	35.1	36.9	1	48.4	62.0	0.215	53.0	530	0.034	9.9
SM30T39AY/CAY	0.2	33	36.7	38.6	40.5	1	53.3	56.3	0.261	58.0	490	0.040	10

1. Pulse test : t_p < 50 ms
2. To calculate maximum clamping voltage at other surge level,use the following formula: $V_{CL}max = V_{CL} - R_D \times (I_{PP} - I_{PPappli})$ where IPPappli is the surge current in the application
3. To calculate V_{BR} or V_{CL} versus junction temperature, use the following formulas:

V_{BR} @ $T_J = V_{BR}$ @ 25 °C x (1 + T x (T_J - 25))

V_{CL} @ $T_J = V_{CL}$ @ 25 °C x (1 + T x (T_J - 25))

4. Surge capability given for both directions for unidirectional and bidirectional types.

Figure 3. Peak pulse power dissipation versus initial junction temperature (typical value)

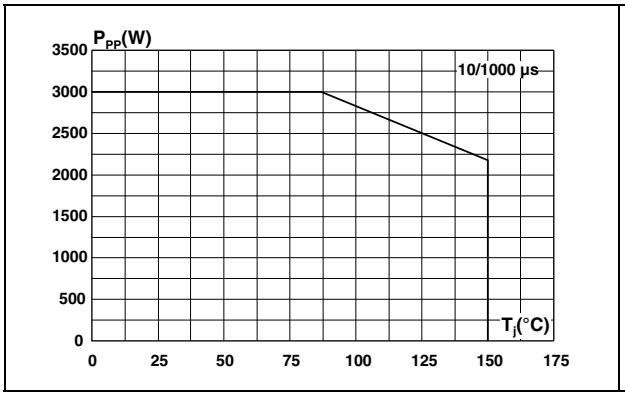


Figure 4. Peak pulse power versus exponential pulse duration (T_j initial = 25 °C)

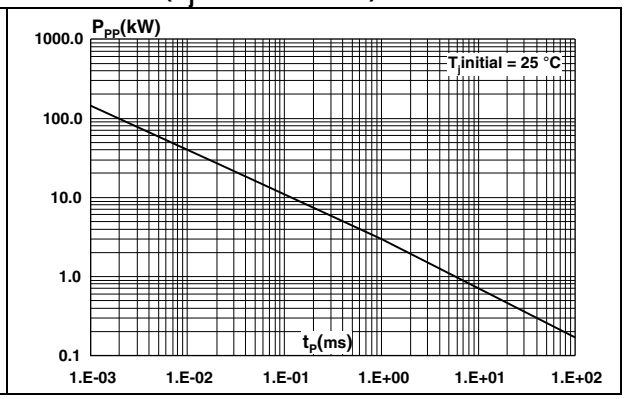


Figure 5. Clamping voltage versus peak pulse current (exponential waveform, maximum values)

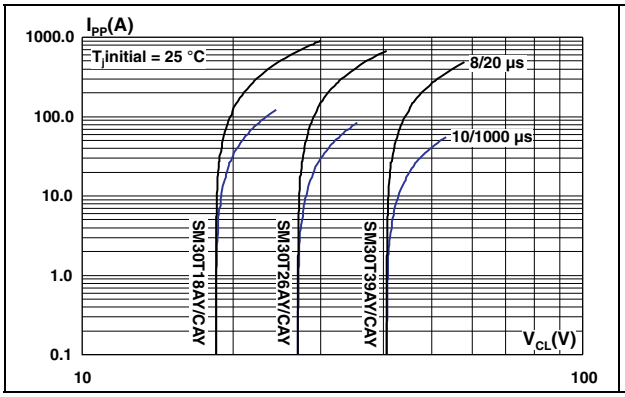


Figure 6. Junction capacitance versus reverse applied voltage for unidirectional types (typical values)

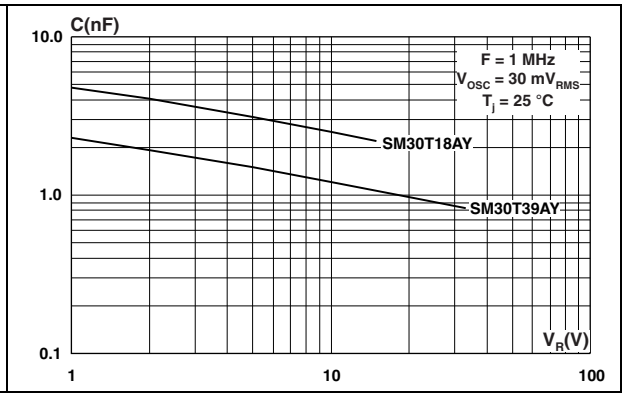


Figure 7. Junction capacitance versus reverse applied voltage for bidirectional types (typical values)

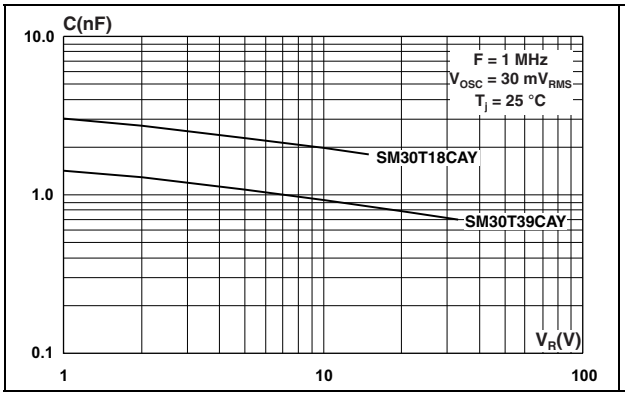


Figure 8. Leakage current versus junction temperature (typical values)

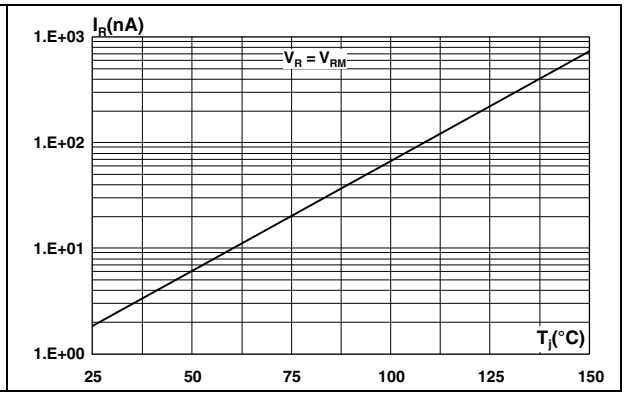


Figure 9. Peak forward voltage drop versus peak forward current (typical values)

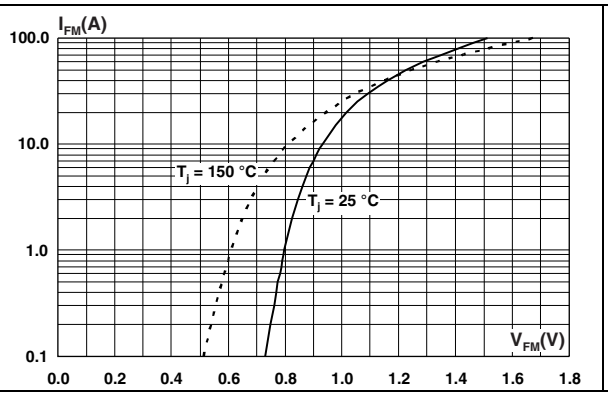


Figure 10. Relative variation of thermal impedance, junction to ambient, versus pulse duration

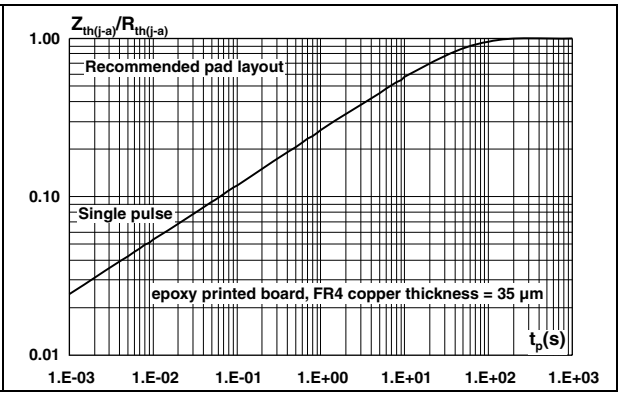


Figure 11. Thermal resistance junction to ambient versus copper surface under each lead

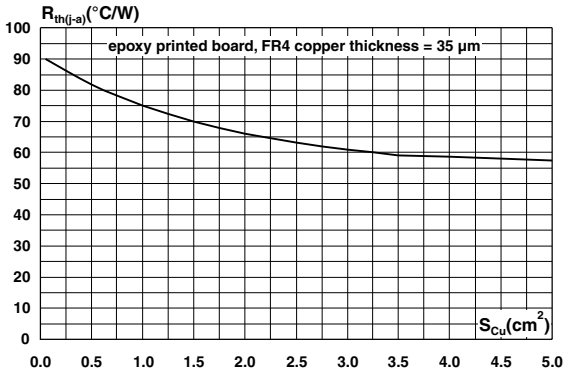


Figure 12. ISO7637-2 pulse 1 response (VS = -100 V)

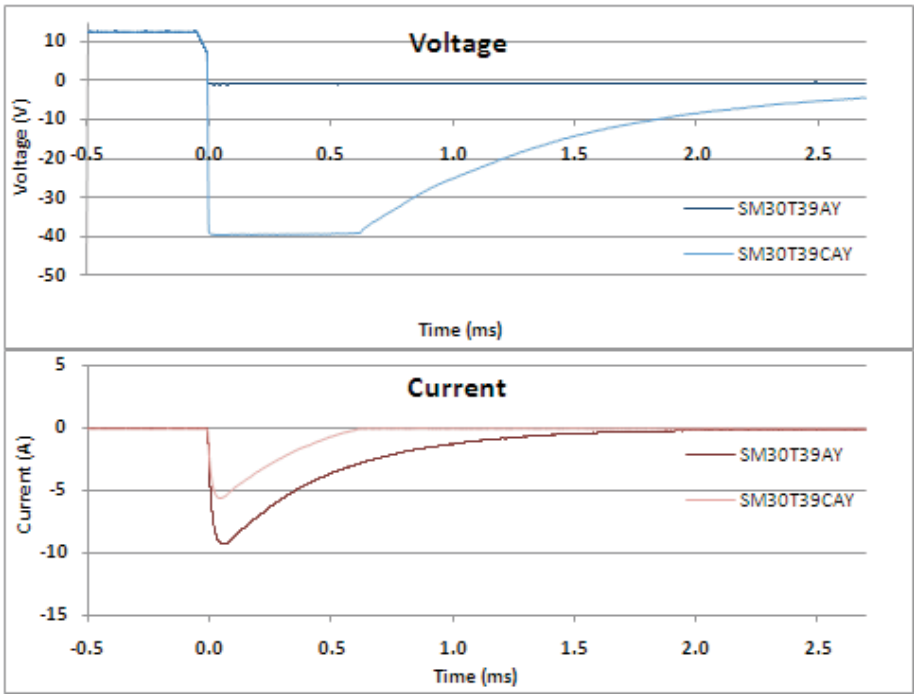


Figure 13. ISO7637-2 pulse 2 response (VS = 50 V)

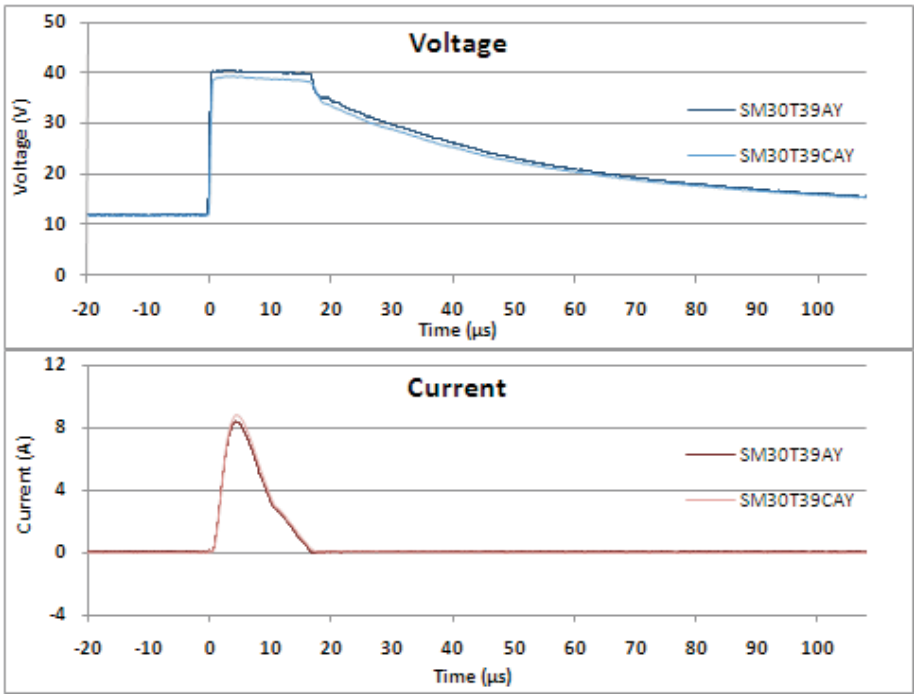


Figure 14. ISO7637-2 pulse 3a response (VS = -150 V)

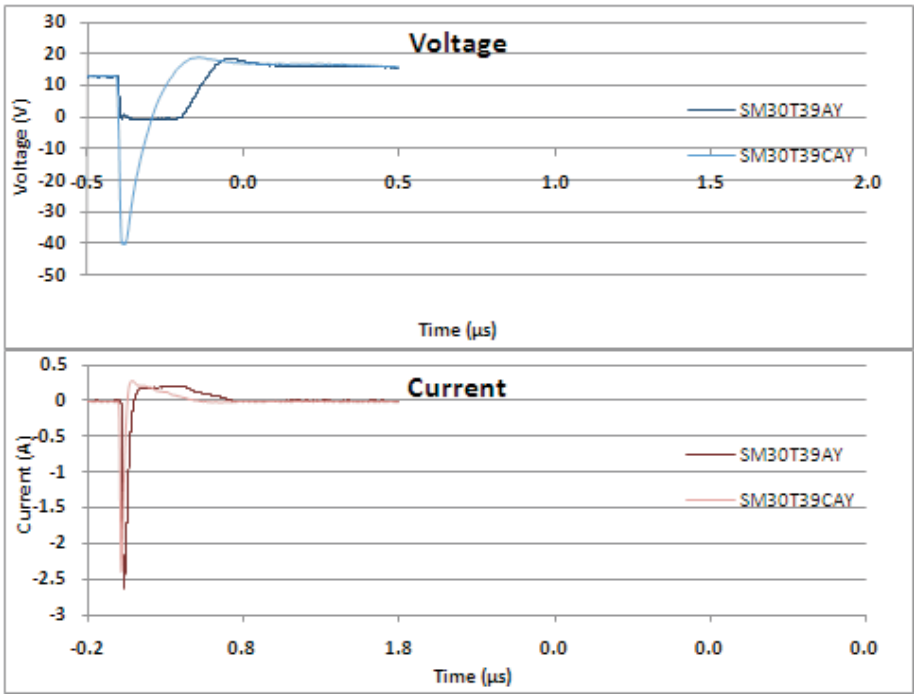
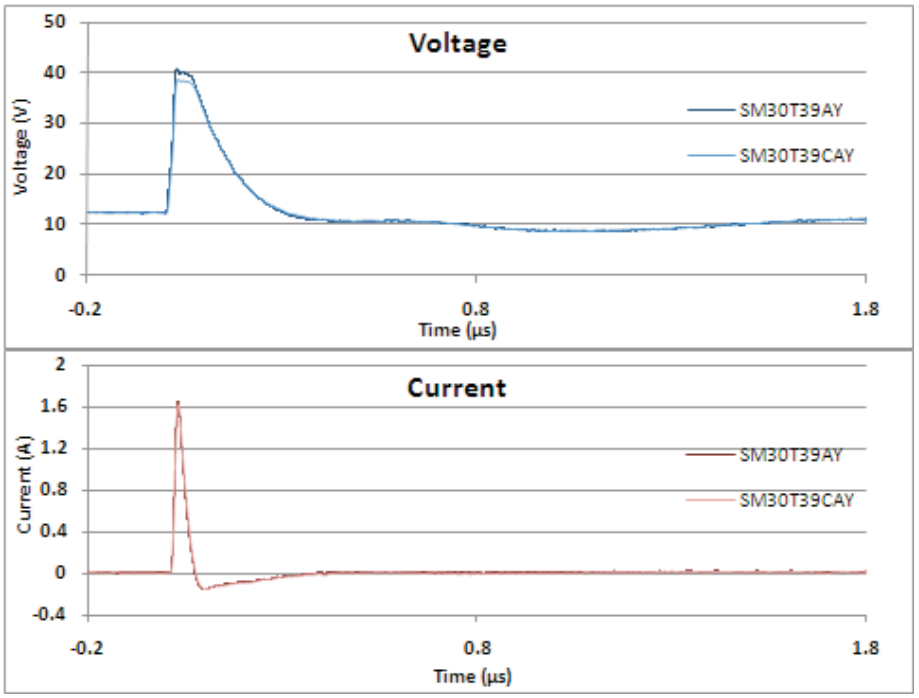


Figure 15. ISO7637-2 pulse 3b response (VS = 100 V)

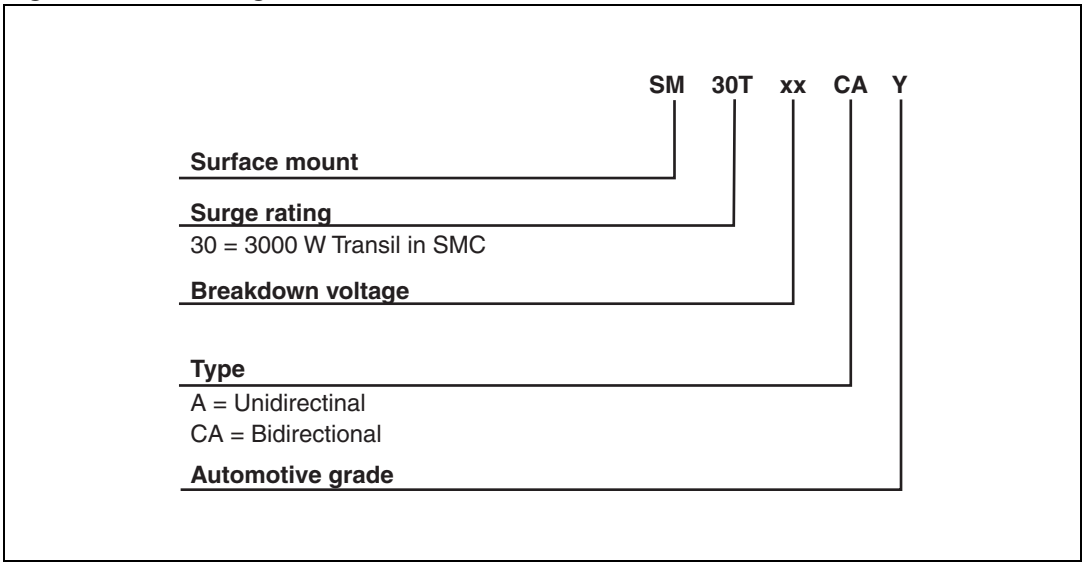


2 Application and design guidelines

More information is available in the Application note AN2689 “Protection of automotive electronics from electrical hazards, guidelines for design and component selection”.

3 Ordering information scheme

Figure 16. Ordering information scheme

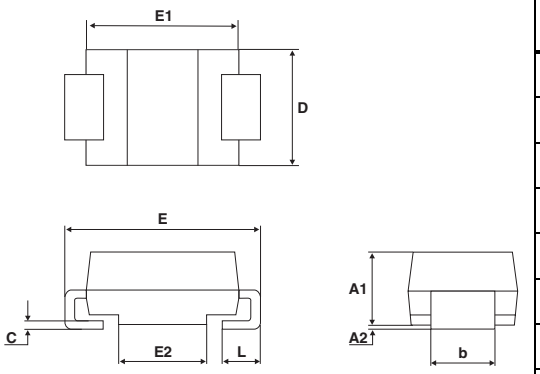


4 Package information

- Case: JEDEC DO-214AB molded plastic over planar junction
- Terminals: solder plated, solderable as per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy is rated UL 94, V0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. SMC dimensions



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.40	0.006	0.016
D	5.55	6.25	0.218	0.246
E	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
L	0.75	1.50	0.030	0.059

Figure 17. SMC footprint dimensions in mm (inches)

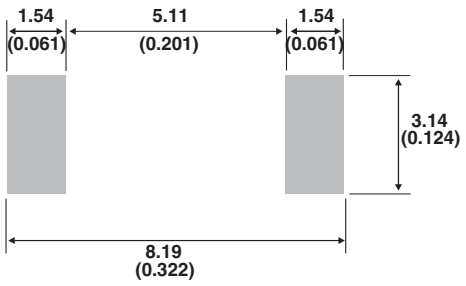
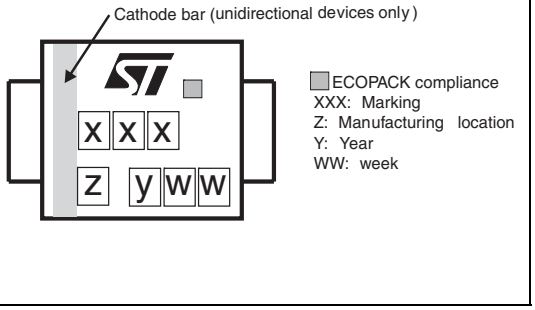


Figure 18. Marking layout(1)



1. Marking layout can vary according to assembly location.

Table 5. Marking

Order code	Marking	Order code	Marking
SM30T18AY	3AAHY	SM30T18CAY	3BAHY
SM30T19AY	3AAIY	SM30T19CAY	3BAIY
SM30T21AY	3AAJY	SM30T21CAY	3BAJY
SM30T23AY	3AAKY	SM30T23CAY	3BAKY
SM30T26AY	3AALY	SM30T26CAY	3BALY
SM30T28AY	3AAEY	SM30T28CAY	3BAEY
SM30T30AY	3AAMY	SM30T30CAY	3BAMY
SM30T33AY	3AANY	SM30T33CAY	3BANY
SM30T35AY	3AAOY	SM30T35CAY	3BAOY
SM30T39AY	3AAPY	SM30T39CAY	3BAPY

5 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SM30TxxAY/CAY(1)	See *Table 5 on page 11*	SMC	0.25 g	2500	Tape and reel

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version. See *Table 3* for list of available devices and their order codes

6 Revision history

Table 7. Document revision history

Date	Revision	Changes
28-Jul-2011	1	Initial release.

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